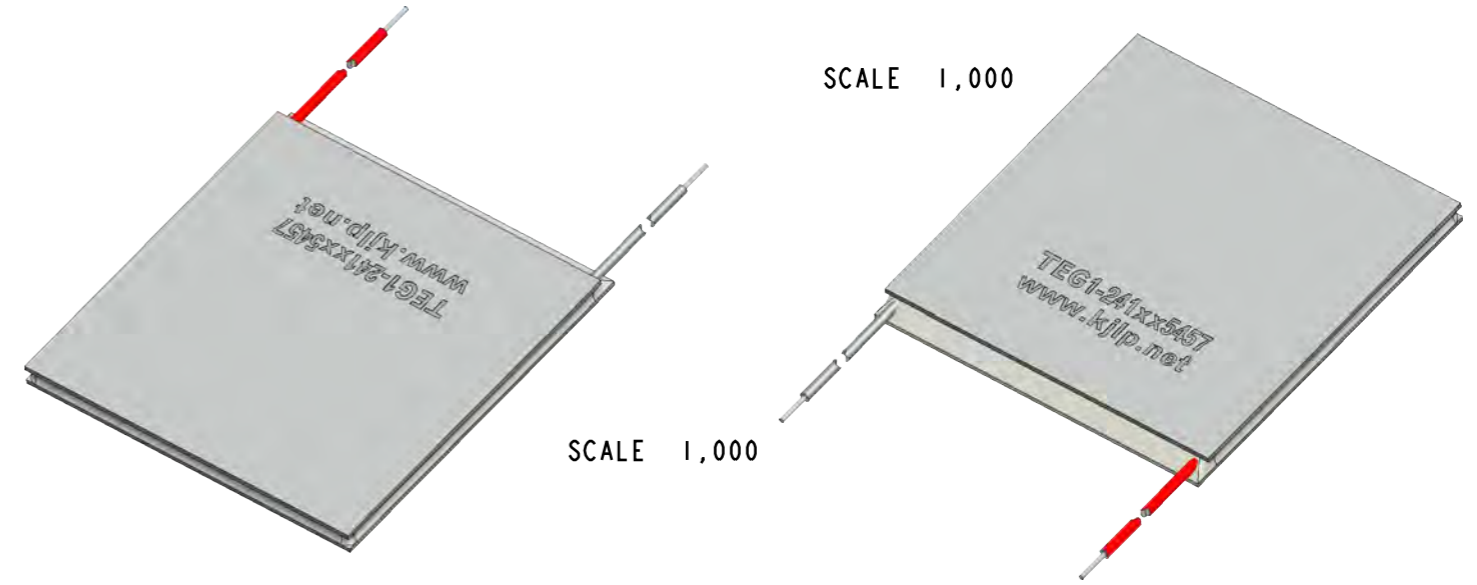
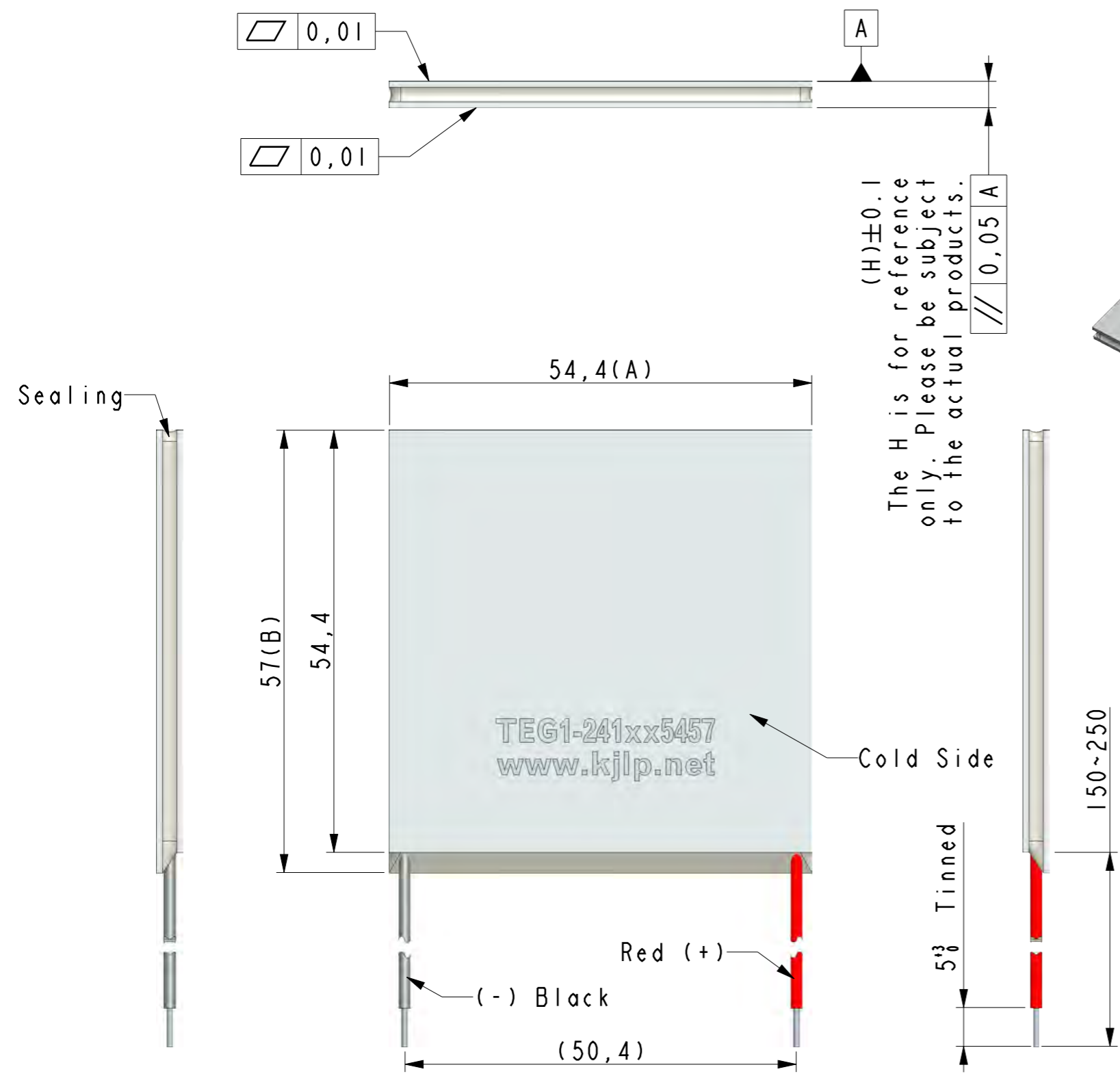


REVISIONS					
REV.	POS.	DESCRIPTION	DATE	DRW	APP
A		INITIAL CREATION	2013/01/01	Gory	Mason



Part Number And Feature:

T	E	G	I	-	2	4	I	x	x	5	4	5	7	Sealing	YES
Thermo	Electric	Chip	Stage	Stack	N & P	Stack	Quantity	R	Load	Dimension	(A)	Dimension	(B)	Operation Temperature(Max.)	200°C(Max.)
														Melting Point	235°C
														Storage Temperature	-60°C~100°C
														RoHS	YES

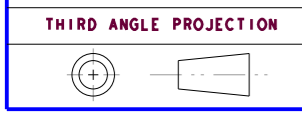
Technical Data:

ITEM	Part NO.	Stack(P&N)	U Load(Max.)	P Load(Max.)	R Load(Max.)	Uoc	P/N Size	DIM(A)	DIM(B)	DIM(H)
1	TEGI-241455457	241	6 V	23.2 W	4.5 Ohm	10 V	1.2*1.4*1.4	54.4	57	RF3.9
2	TEGI-241595457	241	6 V	17.9 W	5.9 Ohm	10 V	1.6*1.4*1.4	54.4	57	RF4.3

Notes:


1. Printing always on cold side.
2. Tolerance of thermo and electric parameters ±10%.
3. Please mount heat sink before you use it. also, please do not exceed the extra voltage at any time.

\*DO NOT SCALE DRAWING



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1. UNLESS OTHERWISE SPECIFIED, DIMENSIONS ARE MM  
2 TOLERANCE ARE AS FOLLOWS:  
0 < X < 2 ± 0.06  
2 < X < 10 ± 0.08  
10 < X < 50 ± 0.12  
50 < X < 100 ± 0.16  
100 < X < 200 ± 0.20  
200 < X < 300 ± 0.30  
ANGLES ± 0.5°

PART NO.	TEGI-241xx5457	DESCRIPTION	241 P&N, 23.2~17.9(Max.), 54.4*57mm						
SIGNATURE		DATE	 昆晶冷片(深圳)电子有限公司 KJLP (SHENZHEN) ELECTRONICS CO., LTD email: kjlp@kjlp.net http:// www.kjlp.net Tel: +86-755-82528352 Fax: +86-755-22639899						
DRAWN BY	Gory	2013/01/01							
CHECKED BY	Justin	2013/01/01							
ENGR	Vivi	2013/01/01							
APPROVED BY	Mason	2013/01/01							
MATERIAL:	ISSUED BY	Jack	2013/01/01	CAD MODLE:	TEGI-241xx5457.prt	SCALE:	1:1	REV:	A
				CAD DWG:	TEGI-241xx5457.drw	SIZE:	A3	SHEET:	1 OF 1